



DMN2004TK

N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected up to 2kV
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: SOT-523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.002 grams (approximate)

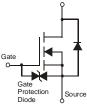


ESD PROTECTED TO 2kV



SOT-523

Top View



Drain

Equivalent Circuit

_ _ __ Top View

G

D

Ordering Information (Note 3)

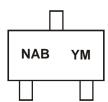
Part Number	Case	Packaging
DMN2004TK-7	SOT-523	3000/Tape & Reel

1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



NAB = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code Key

Notes:

Year	200	6	2007		2008	20	09	2010		2011	2	2012	
Code	Т		U		V		V	Х		Y		Z	
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec	
Code	1	2	3	4	5	6	7	8	9	0	Ν	D	



Maximum Ratings @T_A = 25°C unless otherwise specified

Charac	teristic		Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±8	V
Drain Current (Note 4)	$\begin{array}{lll} \mbox{Steady} & T_{A} = 25^{\circ}\mbox{C}\\ \mbox{State} & T_{A} = 85^{\circ}\mbox{C} \end{array}$		I _D	540 390	mA
Pulsed Drain Current (Note 5)			IDM	1.5	A

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	PD	150	mW
Thermal Resistance, Junction to Ambient	R _{0JA}	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

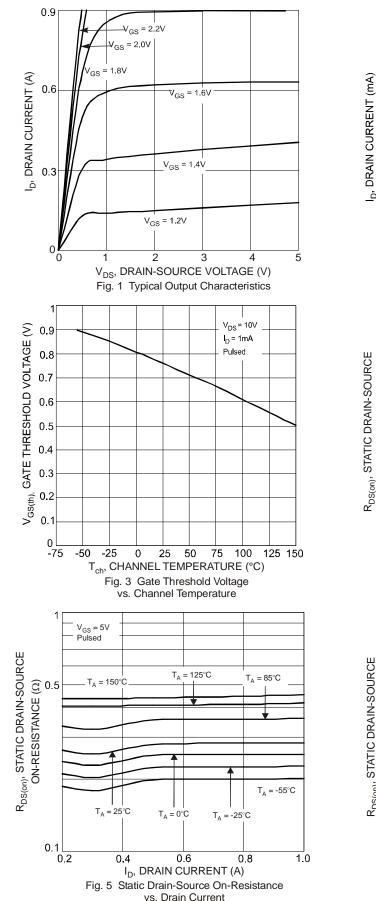
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	20			V	$V_{GS} = 0V, I_D = 10\mu A$	
Zara Cata Valtaga Drain Currant			0.8	300	nA	$V_{DS} = 16V, V_{GS} = 0V$	
Zero Gate Voltage Drain Current	I _{DSS}		0.9	—	nA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS			±1	μΑ	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(th)}	0.5	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
			0.4	0.55		$V_{GS} = 4.5V, I_D = 540mA$	
Static Drain-Source On-Resistance	R _{DS (ON)}	—	0.5	0.70	Ω	$V_{GS} = 2.5V, I_D = 500mA$	
			0.7	0.9		V _{GS} = 1.8V, I _D = 350mA	
Forward Transfer Admittance	Y _{fs}	200		_	ms	$V_{DS} = 10V, I_{D} = 0.2A$	
Diode Forward Voltage (Note 6)	V _{SD}	0.5		1.4	V	$V_{GS} = 0V, I_{S} = 115mA$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	Ciss		—	150	pF		
Output Capacitance	Coss		_	25	pF	−V _{DS} = 16V, V _{GS} = 0V −f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}			20	pF		
SWITCHING CHARACTERISTICS							
Turn-On Delay Time	t _{d(on)}	_	8.5	_	ns		
Rise Time	tr	_	9.1	_	ns	$V_{DD} = 10V, R_L = 47\Omega, I_D = 200mA,$	
Turn-Off Delay Time	t _{d(off)}	_	51	_	ns	$V_{GEN} = 4.5V, R_G = 10\Omega$	
Fall Time	t _f		28		ns		

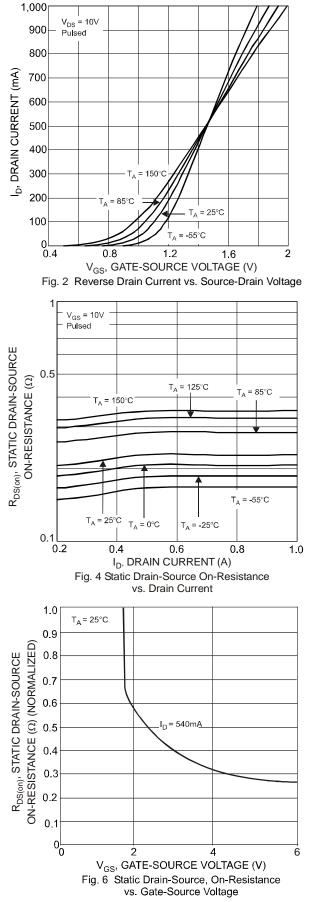
Notes:

4. Device mounted on FR-4 PCB. 5. Pulse width $\leq 10\mu$ S, Duty Cycle $\leq 1\%$

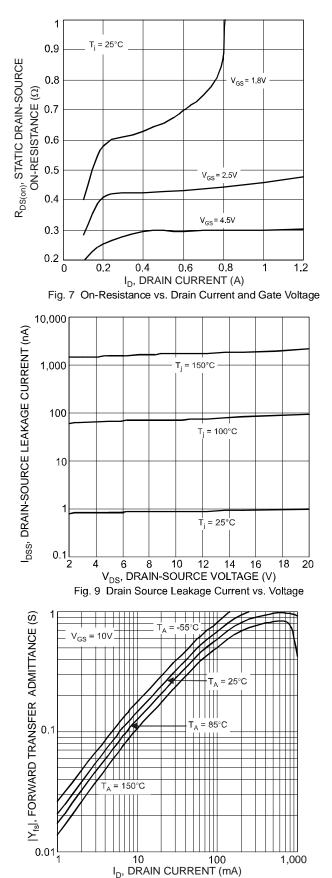
6. Short duration pulse test used to minimize self-heating effect.

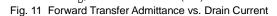


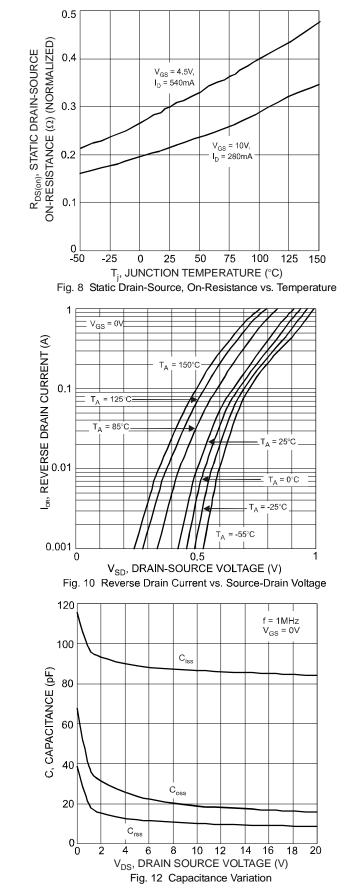






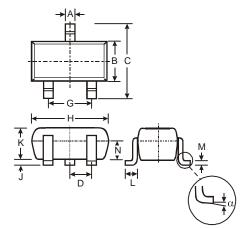






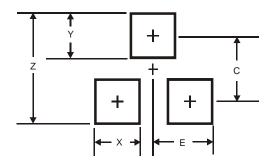


Package Outline Dimensions



SOT-523						
Dim	Min	Max	Тур			
Α	0.15	0.30	0.22			
В	0.75	0.85	0.80			
С	1.45	1.75	1.60			
D			0.50			
G	0.90	1.10	1.00			
Н	1.50	1.70	1.60			
J	0.00	0.10	0.05			
κ	0.60	0.80	0.75			
L	0.10	0.30	0.22			
М	0.10	0.20	0.12			
Ν	0.45	0.65	0.50			
α	0°	8°	_			
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Y	0.51
С	1.3
E	0.7



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